Impedance Matching Power Splitter/Combiner SBTC-2-10-5075+

2 Way-0°

50/75Ω 50 to 1000 MHz

Features

- 50 ohm input, 75 ohm output
- excellent isolation, 20 dB typ.
- very good phase unbalance, 1.0 deg. typ.
- small size, 0.15"x0.15"x0.15"
 temperature stable LTCC base
- small size
- low cost
- aqueous washable
- protected by US patent 6,963,255

Applications

- cable
- 50-75 ohm amplifier splitter



Generic photo used for illustration purposes only CASE STYLE: AT790

+RoHS Compliant The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

	Available Tape and Reel at no extra cost
Reel Size	Devices/Reel
7"	20, 50, 100, 200
13"	500, 1000, 2000

Electrical Specifications

Parameter	Frequency (MHz)	Min.	Тур.	Max.	Unit	
Frequency Range		50		1000	MHz	
Insertion Loss Above 3.0 dB	50 - 500	—	0.7	1.2	dB	
Insertion Loss Above 3.0 db	500 - 1000	—	1.0	1.6	uВ	
Isolation	50 - 500	16	25	—	dB	
Isolation	500 - 1000	15	20	—		
Phase Unbalance	50 - 500	—	—	3	Degree	
	500 - 1000	—	—	5	Degree	
Amplitude Unhelence	50 - 500	_	_	0.6	dB	
Amplitude Unbalance	500 - 1000			0.5	uB	

Maximum Ratings

Parameter	Ratings
Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
Power Input (as a splitter)	0.5W max.
Internal Dissipation	0.125W max

Permanent damage may occur if any of these limits are exceeded.

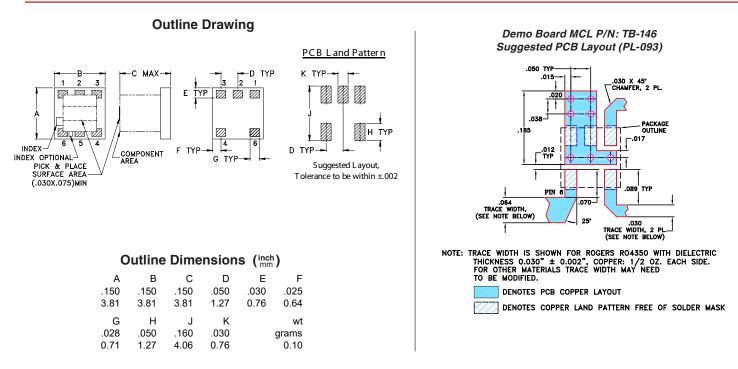
Pin Connections

Function	Pin Number
SUM PORT	6 (50 ohms)
PORT 1	3 (75 ohms)
PORT 2	4 (75 ohms)
GROUND	1,2
NOT USED	5

Electrical Schematic



SBTC-2-10-5075+



Typical Performance Data

				710 00 0							
	Frequency (MHz)	Total (d		Amplitude Unbalance (dB)	Isolation (dB)	Phase Unbalance (deg.)	VSWR S	VSWR 1	VSWR 2		
		S-1	S-2			(0,					
	50.00	3.80	3.49	0.31	29.17	0.08	1.20	1.38	1.30		
	150.00	3.84	3.53	0.30	27.42	0.28	1.20	1.34	1.27		
	250.00	3.85	3.56	0.29	25.23	0.57	1.18	1.29	1.25		
	300.00	3.86	3.58	0.28	24.22	0.67	1.17	1.26	1.23		
	400.00	3.87	3.62	0.25	22.58	0.95	1.14	1.19	1.20		
	450.00	3.86	3.62	0.24	21.92	1.08	1.12	1.17	1.19		
	500.00	3.88	3.65	0.23	21.35	1.21	1.10	1.14	1.18		
	600.00	3.91	3.72	0.19	20.45	1.47	1.06	1.13	1.18		
	650.00	3.92	3.74	0.18	20.11	1.53	1.04	1.14	1.19		
	700.00	3.95	3.79	0.16	19.86	1.66	1.03	1.17	1.21		
	800.00	4.02	3.89	0.13	19.50	1.80	1.05	1.24	1.25		
	850.00	4.05	3.95	0.10	19.40	1.84	1.07	1.27	1.27		
	900.00	4.10	4.02	0.09	19.33	1.93	1.09	1.30	1.29		
	950.00	4.14	4.09	0.05	19.32 19.39	2.00	1.10	1.32	1.30		
	1000.00	4.19	4.16	0.03	19.39	1.99	1.12	1.34	1.30		
				1. Total Loss = Insertion	n Loss + 3dB splitter I	OSS.					
TOTAL LOSS				ISOLA					VSWR		
RF level -10 dBm		_	30	at RF level -10 dBm				at RF level -10	IBm		
——S-1(dB) —-S-2	2(dB)						1.5			#1-VSWR#2-\	
			28				1.4		#3-V3VVR	#1-VSVVR#2-1	JOVK
		1	9 26				1.4	+0			
			Z 20				<u>⊯</u> 1.3	30			1
		-	E 24				법 1.3 MS 7 1.2		-		
			(gp) NOITAIOS 25 25 25				> 1.2	20	and the second second		
		-	<u>S</u> 22							~	
			20				1.1	10	+		
		4				+					1
150 250 350 450 550 650	0 750 850 950 1	050	18				1.0		250 450	650 8	+ 50
			ţ			850 1050		30			50
FREQUENCY (M	1 H z)			FRE	QUENCY (M H z)				FREQU	IENCY (MHz)	

Additional Notes

4.6

4.2 TOTAL LOSS 3.8 34 3.0

50

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions. C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp



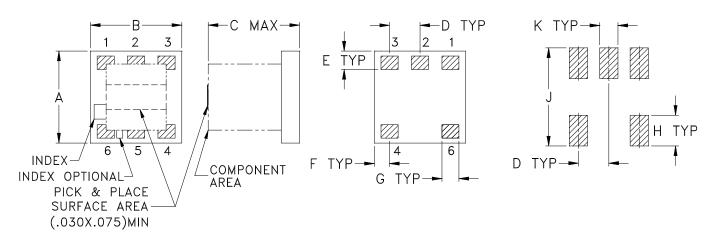
1050

Case Style

Outline Dimensions

PCB Land Pattern

AT790



Suggested Layout, Tolerance to be within ±.002

CASE #	А	В	С	D	Е	F	G	Н	J	K	L	WT. GRAMS
AT790	.150	.150	.150	.050	.030	.025	.028	.050	.160	.030		.10
	(3.81)	(3.81)	(3.81)	(1.27)	(0.76)	(0.64)	(0.71)	(1.27)	(4.06)	(0.76)		

Dimensions are in inches (mm). Tolerances: 2 Pl. <u>+</u>.01; 3 Pl. <u>+</u>.005

Notes:

- 1. Open style, Ceramic base.
- 2. Termination finish: Silver palladium or gold over nickel based on stock availability.



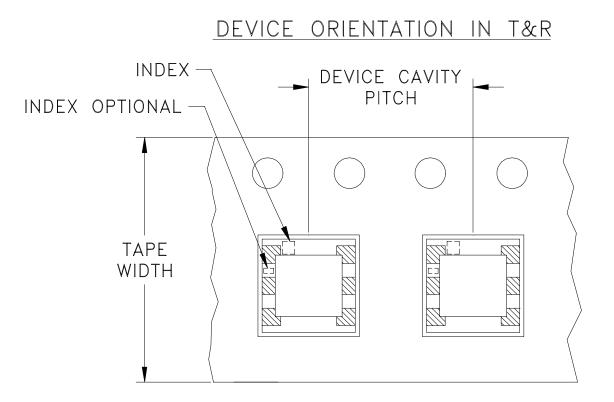


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RF/IF MICROWAVE COMPONENTS

The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

Tape & Reel Packaging TR-F15



DIRECTION OF FEED

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel
			20
			50
		7	100
12	8		200
			500
		13	1000
			2000

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

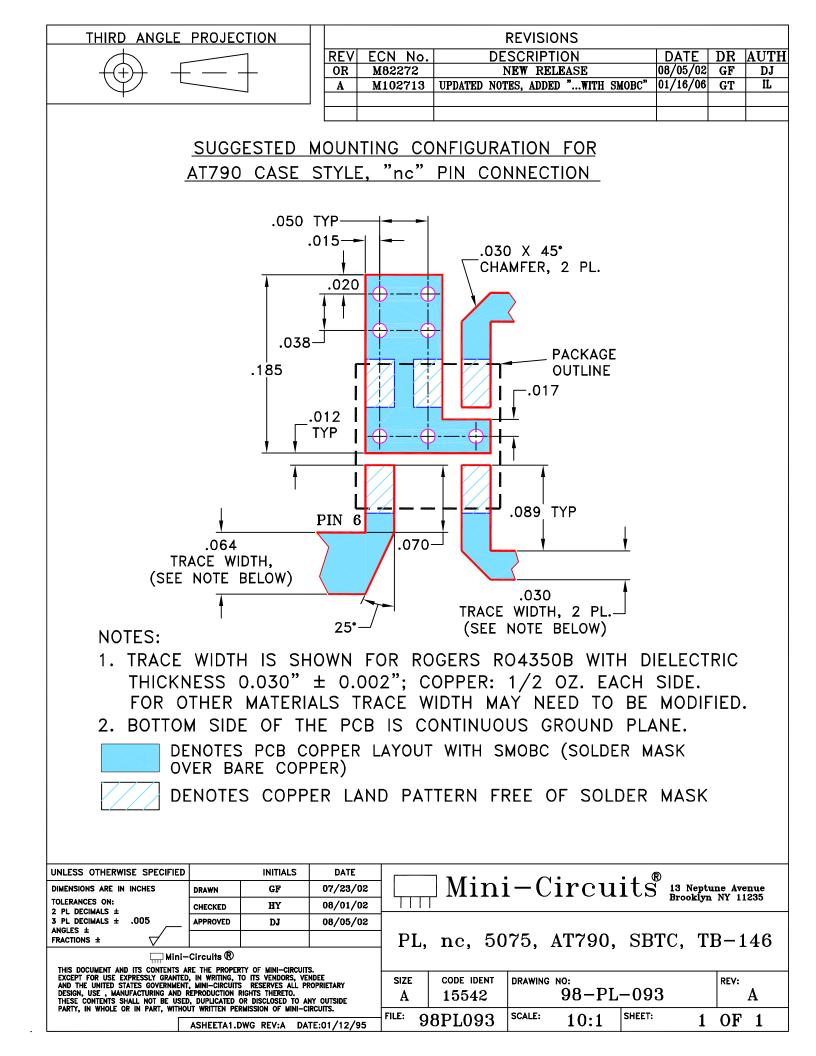
Go to: www.minicircuits.com/pages/pdfs/tape.pdf

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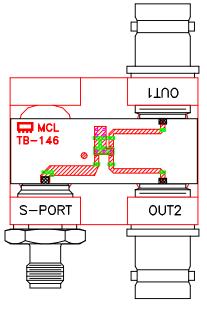
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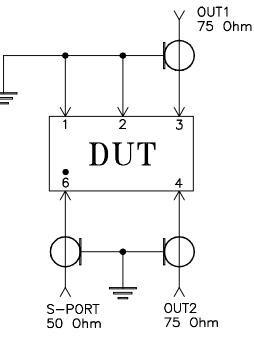
 Mini-Circuits ISO 9001 & ISO 14001 Certified
 • So 14001 Certified
 • So 14001 Certified



Evaluation Board and Circuit



TB-146



Schematic Diagram

Notes:

- 1. 50 Ohm SMA AND 75 Ohm BNC Female connectors.
- 2. PCB Material: Rogers R04350 or equivalent, Dielectric Constant=3.5, Thickness=.030 inch.

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Mini-Circuits

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215
ENV/02T1 Rev: B 02/25/11 M130240 File: EN		

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